

60A 200V Fast recovery diode

1 Description

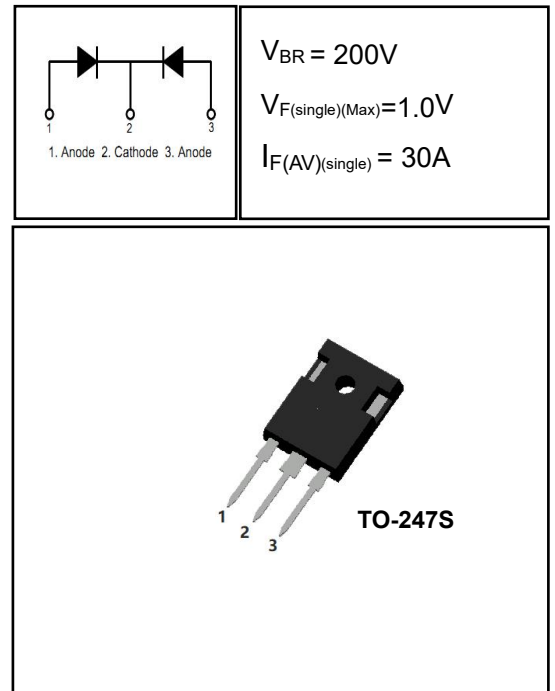
60A, 200V Ultrafast Diodes They have a low forward voltage drop and are of planar, silicon nitride passivated, ion-implanted, epitaxial construction. These devices are intended for use as energy steering/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and ultrafast recovery with soft recovery characteristics minimizes ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistor

2 Features

- Low power loss,
- high efficiency Low forward voltage,
- high current capability High surge capacity
- Super fast recovery times
- high voltage

3 Applications

- Switching Power Supply
- Power Switching Circuits
- Inverter power supply



4 Electrical Characteristics

4.1 Absolute Maximum Ratings (Tc=25°C, unless otherwise noted)

PARAMETER		SYMBOL	VALUE	UNIT
Peak Repetitive Reverse Voltage		V_{RRM}	200	V
Working Peak Reverse Voltage		V_{RWM}	200	V
DC Blocking Voltage		V_R	200	V
Average Rectified Forward Current(single)	TO-247/3P/3PN, TC=135°C	$I_{F(AV)}$	30	A
Average Rectified Forward Current(double)			60	A
Repetitive Peak Surge Current(single)		I_{FRM}	40	A
Nonrepetitive Peak Surge Current(single)	t=8.3ms	I_{FSM}	350	A
Avalanche Energy(single)	L=1mH	E_{AS}	50	mJ
Operating Junction Temperature Range		T_j	-55~175	°C
Storage Temperature Range		T_{stg}	-65~175	°C

4.2 Thermal Characteristics

PARAMETER	SYMBOL	VALUE	UNIT
Thermal Resistance, Junction to Case-sink	R_{thJC}	0.65	°C/W

4.3 Electrical Characteristics (Tc=25°C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Maximum Instantaneous Forward Voltage	V _F	I _F = 10A	-	0.79	-	V
		I _F = 20A	-	0.85	-	V
		I _F = 30A	-	0.92	1.0	V
		I _F = 30A, T _C = 150°C	-	-	0.85	V
Maximum Instantaneous Reverse	I _R	V _R = 200V	-	-	5	μA
		V _R = 200V, T _C = 150°C	-	-	500	μA
Maximum Reverse Recovery Time	t _{rr}	V _R =30V I _F =1A -di/dt=50A/us	-	23	35	ns
Total capacitance	C _{tot}	V _R =0V f=1MHz	-	180	-	pF
DC Blocking Voltage	V _{BR}	I _R =100μA	220	250	-	V

DEFINITIONS

V_F = Instantaneous forward voltage (pw = 300μs, D = 2%).

I_R = Instantaneous reverse current.

RθJC = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

5 Typical characteristics diagrams

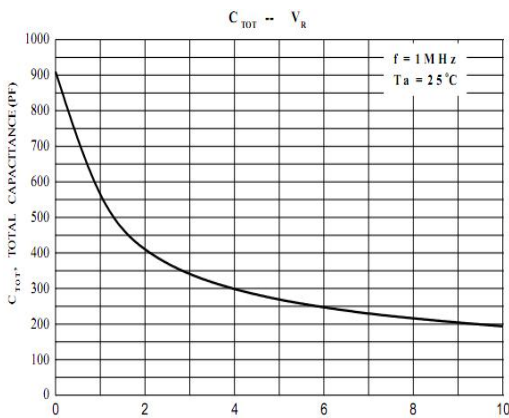


FIGURE 1. Total capacitance vs Voltage

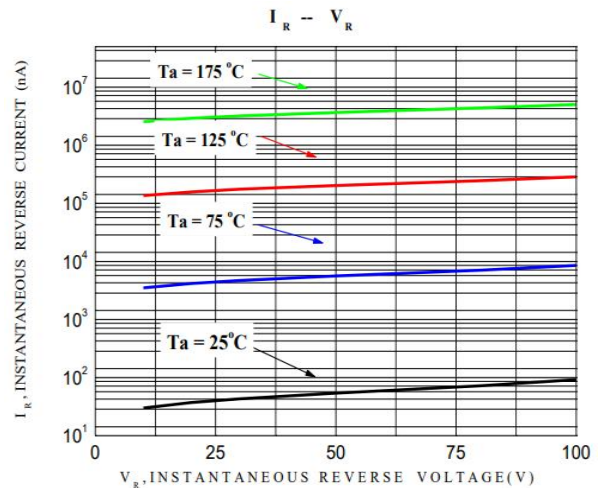


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

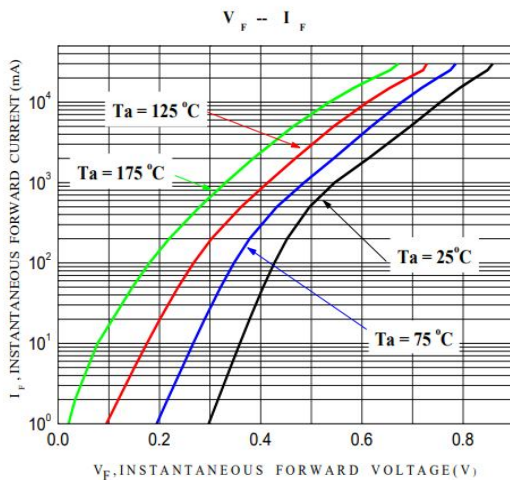


FIGURE 3. FORWARD CURRENT vs FORWARD VOLTAGE

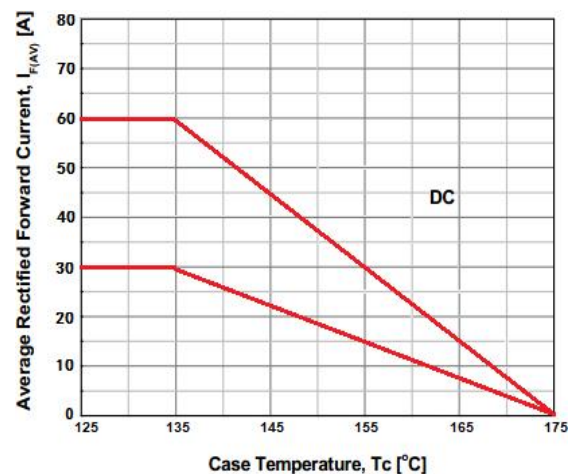


FIGURE 4. CURRENT DERATING CURVE

6 Typical Test Circuit and Waveform

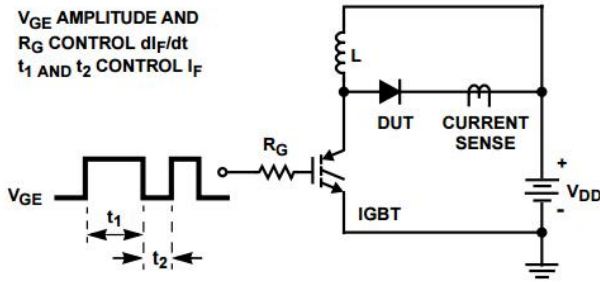


FIGURE 5. trr TEST CIRCUIT

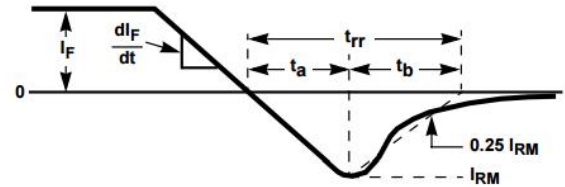


FIGURE 6. trr WAVEFORMS AND DEFINITIONS

$R < 0.1\Omega$
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
 $Q_1 = \text{IGBT (} BV_{CES} > \text{DUT } V_{R(AVL)})$

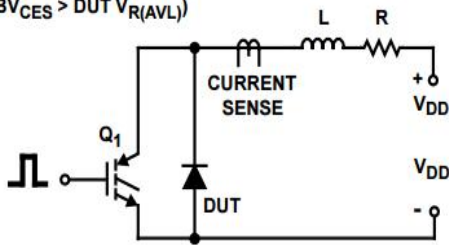


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT FIGURE

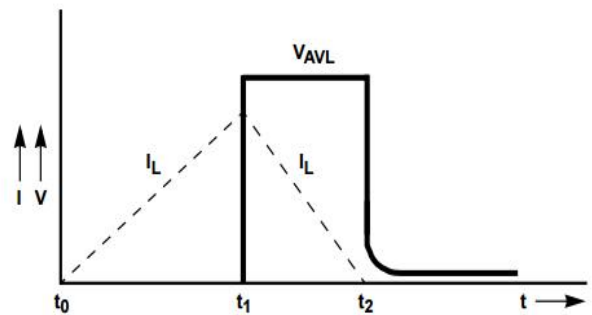


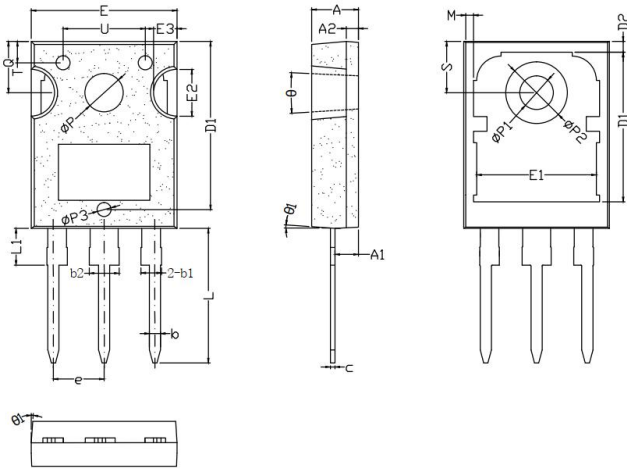
FIGURE8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

8 Product Specifications and Packaging Models

Product Model	Package Type	Mark Name	RoHS	Package	Quantity
MUR6020NCA	TO-3PN	MUR6020NCA	Pb-free	Tube	300/box
MUR6020BCA	TO-247S	MUR6020BCA	Pb-free	Tube	300/box

9 Dimensions

TO-247S PACKAGE OUTLINE DIMENSIONS



SYMBOL	mm		
	MIN	NOM	MAX
*A	4.90	5.00	5.10
*A1	2.35	2.50	2.65
A2	1.20	1.30	1.40
*b	1.25	1.20	1.30
*b1	1.95	2.10	2.25
*b2	2.95	3.10	3.25
*c	0.45	0.50	0.55
*D	19.90	20.00	21.10
D1	15.80	16.00	16.20
D2	1.00	1.15	1.30
*E	15.50	15.60	15.70
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
*e	5.40	5.44	5.48
*L	14.20	14.40	14.60
*L1	-	-	4.20
* ϕP	4.00	4.10	4.20
* $\phi P1$	3.50	3.60	3.70
$\phi P2$	6.40	6.60	6.80
$\phi P3$	1.45	1.50	1.65
q	5.30	5.50	5.70
*s	5.40	5.50	5.60
T	2.10	2.30	2.20
U	8.60	8.80	9.00
θ	3°	6°	9°
$\theta 1$	3°	6°	9°

10 Attentions

- Jiangsu Donghai Semiconductor Co.,Ltd. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Jiangsu Donghai Semiconductor Co.,Ltd. products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

11 Appendix

Revision history:

Date	REV.	Description	Page
2017.09.1	1.0	Original	
2022.01.01	1.1	Modify company name	all